

Part Number: 873402024

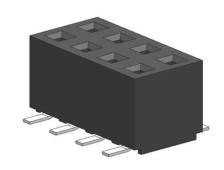
Product Description : 2.00mm Pitch Milli-Grid Receptacle, Surface Mount (Very Low Profile), Top Entry, with Locating Pegs, 0.38µm Gold (Au) Plating, 20

Circuits, Lead-Free, Tube, Black

Series Number: 87340

Status: Active

Product Category: PCB Headers and Receptacles



Documents & Resources

Drawings

873402024 sd.pdf

PK-87264-0001-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

503940001-AS-000.pdf

PS-87340-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44
China RoHS	⊚ per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87340
Description	2.00mm Pitch Milli-Grid Receptacle, Surface Mount (Very Low Profile), Top Entry, with Locating Pegs, 0.38µm Gold (Au) Plating, 20 Circuits, Lead-Free, Tube, Black
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	Milli-Grid
UPC	822348473496

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	125V

Physical

Circuits (Loaded)	20
Circuits (maximum)	20
Color - Resin	Black
Durability (mating cycles max)	25
Flammability	94V-0
Glow-Wire Capable	No
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.443/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	Yes
PCB Retention	None
Pitch - Mating Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	14
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	265

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Vertical Through Hole Headers	<u>87758</u>
Milli-Grid Vertical Surface Mount Headers	<u>87759</u>
Milli-Grid Right-Angle Through Hole Headers	<u>87760</u>

This document was generated on Aug 05, 2025